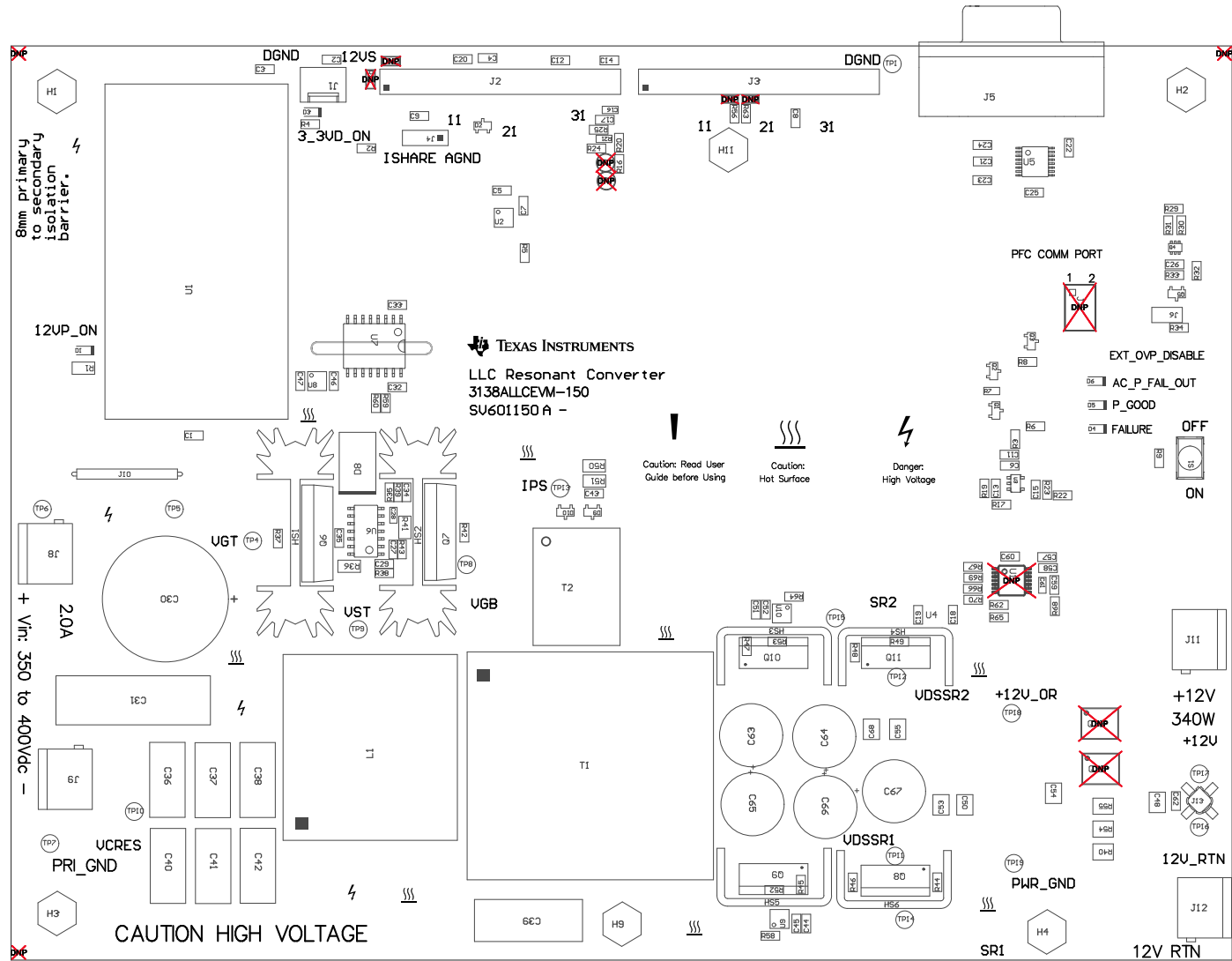
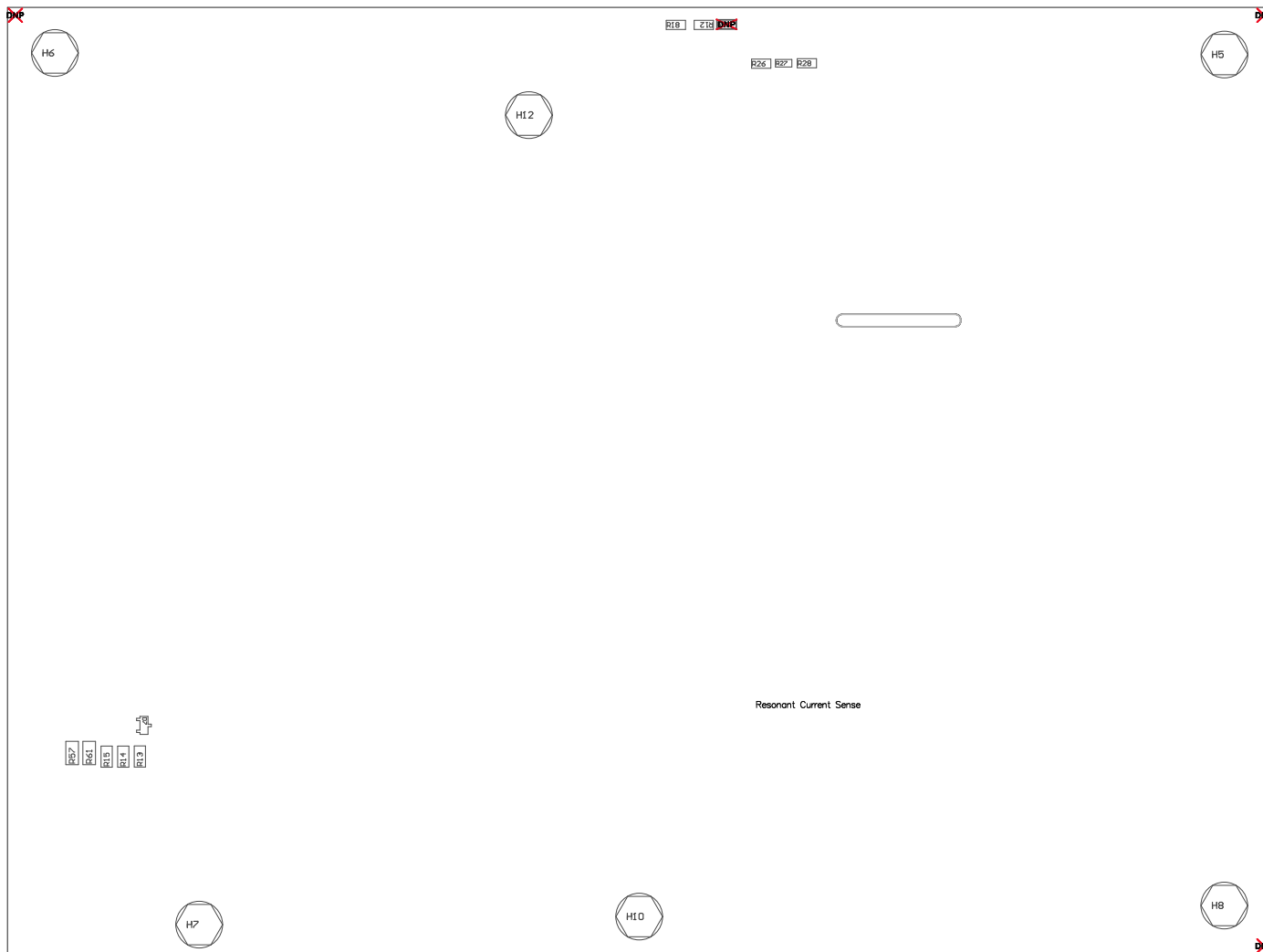


221 ■ These assemblies are ESD sensitive, ESD precautions shall be observed.
 222 ■ These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
 223 ■ These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: SU601150	REV: A	SUN REV: Not In VersionControl
IGNORE -> Silkscreen Top			
PLOT NAME = Top Assembly Drawing	GENERATED : 2/18/2015 10:56:35 AM	TEXAS INSTRUMENTS	



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: SU601150	REV: A	SUN REV: Not In VersionControl
	IGNORE -> Bottom Screen 2		
PLOT NAME = Bottom Assembly Drawing	GENERATED : 2/18/2015	10:56:36 AM	TEXAS INSTRUMENTS

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